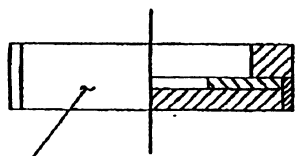
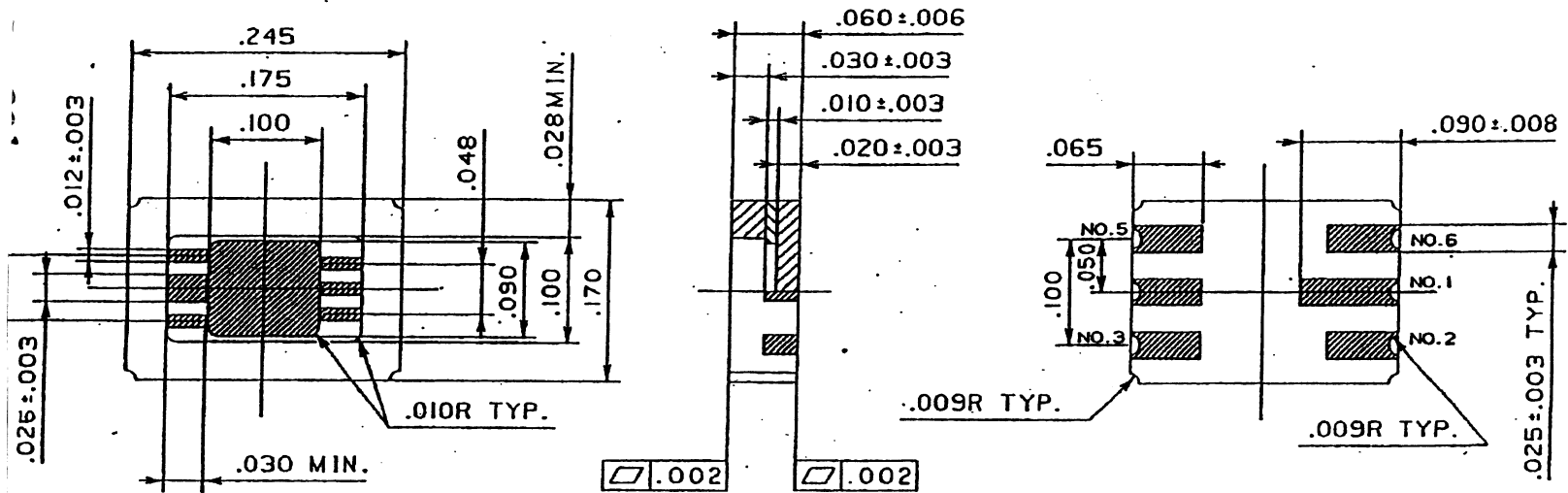


SSM P/N LCC00603



CERAMIC
KYOCERA A440(BLACK)

NOTES

1. PLATING THICKNESS TO BE PER CUSTOMER'S SPECIFICATION.
2. SEAL AREA TO BE NOT METALLIZED.
3. DIE ATTACH AREA TO BE METALLIZED.
4. DIE ATTACH PAD IS ELECTRICALLY CONNECTED TO PIN NO.3.
5. LEAD RESISTANCE: 0.10Ω MAX.

NAME				6 LEAD CHIP CARRIER				TOLERANCE UNLESS OTHERWISE SPECIFIED				DRAWN				CHECKED				APPROVED				DATE															
SCALE				10 / 1				MATERIAL				S. SH				K.K				K.M				M.K				NOV.14, '91											
AS INDICATED				±.005				UNLESS OTHERWISE SPECIFIED				S. Shima				H. Shima				T. Asu				DRAWING NO.				SHEET											
CHANGED				DATE				DRAWN				CHECKED				APPROVED				KYOCERA				KYOCERA CORPORATION				KYOTO JAPAN				KD-E91895				1/1			



